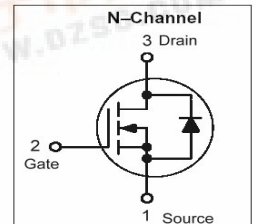
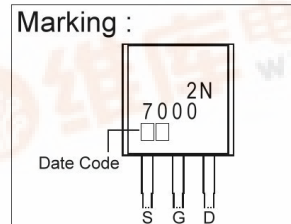
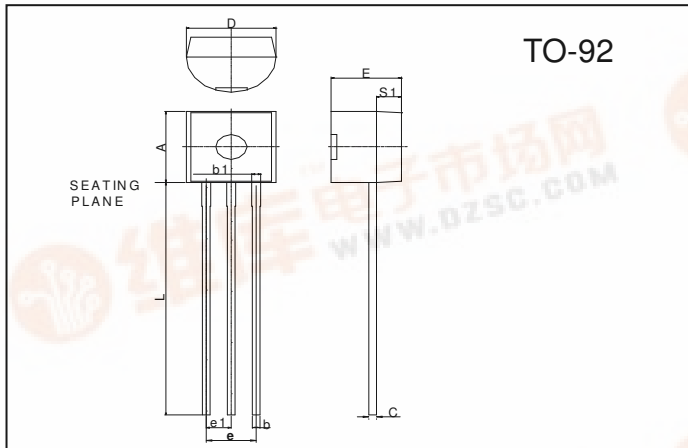


GTM**CORPORATION**ISSUED DATE :2004/02/18
REVISED DATE :2006/10/30F**G2N7000****N-CHANNEL ENHANCEMENT MODE MOSFET****Description**

The G2N7000 is designed for high voltage, high speed applications such as switching regulators, converters, solenoid and relay drivers.

Package Dimensions

REF.	Millimeter		REF.	Millimeter	
	Min.	Max.		Min.	Max.
A	4.45	4.7	D	4.44	4.7
S1	1.02	-	E	3.30	3.81
b	0.36	0.51	L	12.70	-
b1	0.36	0.76	e1	1.150	1.390
C	0.36	0.51	e	2.42	2.66

Absolute Maximum Ratings at Ta = 25°C

Parameter		Symbol	Ratings	Unit
Operating Junction and Storage Temperature Range		Tj, Tstg	-55 ~ +150	°C
Drain-Source Voltage		V _{DSS}	60	V
Gate-Source Voltage	-Continuous	V _{GS}	±20	V
	-Non-repetitive (tp ≤ 50us)	V _{GSM}	±40	V
Drain Current		I _D	200	mA
		I _{DM}	500	
Power Dissipation	Ta=25°C	P _D	0.35	W
	Derate above 25°C		2.8	
Thermal Resistance, Junction-to-Ambient		R _{θJA}	357	°C/W
Maximum Lead Temperature for Soldering Purposes, 1/16" from case for 10 seconds		T _L	300	°C

Electrical Characteristics (Tc = 25°C unless otherwise noted)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Drain-Source Breakdown Voltage	V _{(BR)DSS}	60	-	-	V	V _{GS} =0, I _D =250uA
Gate Threshold Voltage	V _{GS(th)}	0.8	-	3.0	V	V _{DS} =V _{GS} , I _D =1.0mA
Gate Body Leakage Current	I _{GSS}	-	-	±100	nA	V _{GS} =±20V, V _{DS} =0
Zero Gate Voltage Drain Current	I _{DSS}	-	-	1	uA	V _{DS} =60V, V _{GS} =0
On-State Drain Current	I _{D(ON)}	75	-	-	mA	V _{GS} =4.5V, V _{DS} =10V
Static Drain-Source on-State Resistance	R _{DS(ON)}	-	-	5.0	Ω	V _{GS} =10V, I _D =500mA
		-	-	6.0		V _{GS} =4.5V, I _D =75mA
Drain-Source on-Voltage	V _{DS(ON)}	-	-	2.5	V	V _{GS} =10V, I _D =500mA
		-	-	0.45		V _{GS} =4.5V, I _D =75mA
Forward Transconductance	G _{FS}	100	-	-	mS	V _{DS} =10 V, I _D =200mA
Input Capacitance	C _{iss}	-	-	60	pF	V _{DS} =25V, V _{GS} =0V, f=1MHz
Output Capacitance	C _{oss}	-	-	25		
Reverse Transfer Capacitance	C _{rss}	-	-	5		

Switching Characteristics (Note 1)

Turn-on Delay Time	t_{on}	-	-	10	ns	$V_{DD}=15V, I_D=500mA$ $R_G=25\Omega, R_L=30\Omega, V_{gen}=10V$
Turn-off Delay Time	t_{off}	-	-	10		

Note 1. Pulse Test: Pulse Width $\leq 300\mu s$, Duty cycle $\leq 2\%$.

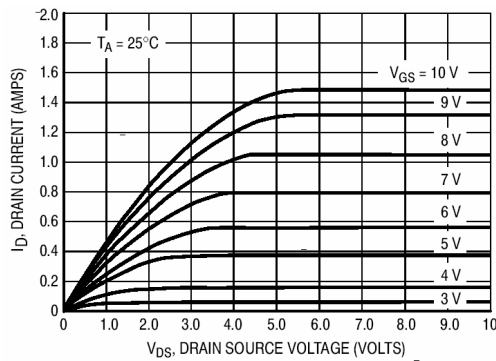
Characteristics Curve

Figure 1. Ohmic Region

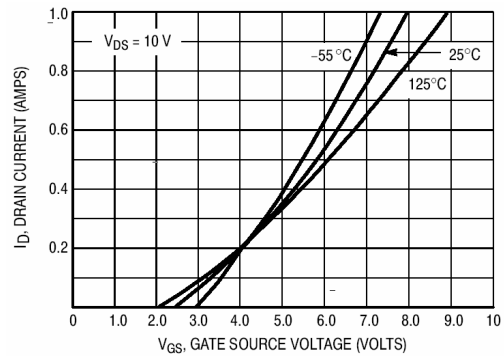


Figure 2. Transfer Characteristics

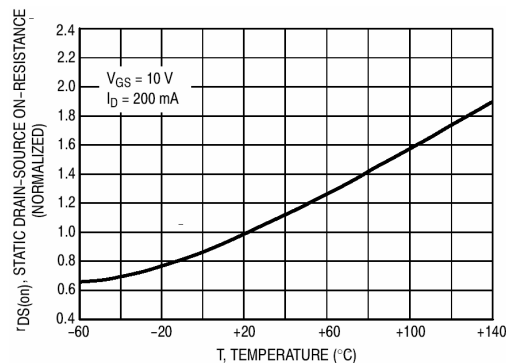


Figure 3. Temperature versus Static Drain-Source On-Resistance

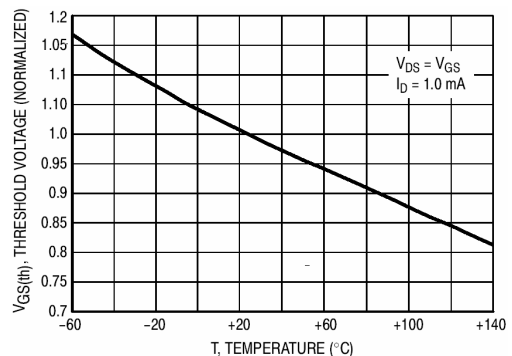


Figure 4. Temperature versus Gate Threshold Voltage

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